

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Title: METHOD OF PLANARIZING TIPS OF PROBE ELEMENTS OF A PROBE CARD

ASSEMBLY (As Amended)

Inventor(s): Eldridge, et al.

Serial No.: 08/554,902

Filing Date: 11/09/95

To: Commissioner of Patents and Trademarks

Washington, D.C. 20231

AMENDMENT

Please enter this amendment.

In the Claims

Please amend the claims, as follows:

(TWICE AMENDED) [Method of planarizing tips] In a probe card assembly, a method of altering the orientation of probe elements for probing semiconductor devices [of a probe card assembly], comprising:

providing a probe card;

providing a support substrate with plurality of probe elements for probing semiconductor devices [a support substrate [having a top surface, a bottom surface, and a plurality of probe elements extending from the top surface, each probe element having a tip at an end distal from the top surface of the support substrate];

mounting the support substrate on [a] the probe card [having a top surface, the bottom surface of the support substrate opposing the top surface of the probe card, said support substrate having an orientation, said probe card having an orientation]; and

[adjusting] altering the orientation of the support substrate relative to the probe card [without altering the orientation of the probe card, so as to planarize the tips of the probe elements] .

